

■ Applications

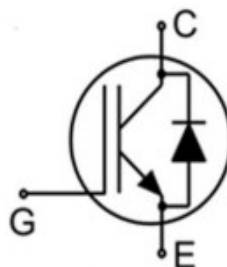
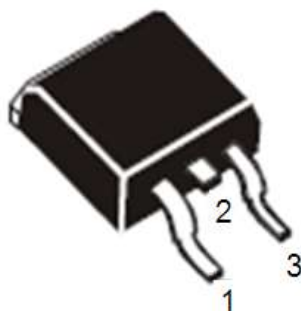
- Inverter
- Welding converters
- Power Factor Correction (PFC)
- Uninterruptible Power Supply (UPS)
- Converters with high switching frequency

■ Features

- Low $V_{CE(sat)}$
- High speed switching
- Short circuit withstand time – 5 μ S
- High ruggedness, temperature stable
- Positive temperature coefficient in $V_{CE(sat)}$
- Enhanced avalanche capability
- RoHS and Halogen-Free Compliant

■ Product Summary

V_{CES}	650	V
I_C	30	A
$V_{CE(sat)}, Typ@15V$	1.65	V



TO-263

Gate: 1
Collector: 2
Emitter: 3

Marking	Package	Packaging	Min. package quantity
MLB30N065J2F	TO-263	Tape & Reel	800





■ Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

Parameter	Symbol	Ratings	Unit
Collector-emitter Voltage	V_{CES}	650	V
DC collector current, limited by T_{jmax} TC=25°C TC=100°C	I_C	60 30	A
Pulsed collector current, tp limited by T_{jmax}	$I_{C\ Pulse}$	90	A
Diode forward current, limited by T_{jmax} TC=25°C TC=100°C	I_F	60 30	A
Diode Pulsed current, tp limited by T_{jmax}	$I_{F\ Pulse}$	90	A
Continuous Gate-emitter voltage	V_{GE}	±20	V
Short circuit withstand time $V_{GE}=15V, V_{CC} \leq 400V, T_j \leq 150^\circ C$	t_{SC}	5	μs
Power Dissipation (TC=25°C)	P_D	187	W
Junction Temperature	T_j	175	°C
Storage Temperature	T_{STG}	-55-175	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

■ Thermal Characteristics

Parameter	Symbol	Max	Unit
IGBT Maximum Junction-to-Case	$R_{\theta JC}$	0.8	°C/W
Diode Maximum Junction-to-Case	$R_{\theta JC}$	1.4	°C/W
Maximum Junction-to-Ambient	$R_{\theta JA}$	60	°C/W

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.





■ Electrical Characteristics (Tc=25°C unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static Characteristics						
Gate-emitte Breakdown Voltage	BV_{CES}	$V_{GE}=0V, I_C=250\mu A$	650	-	-	V
Zero gate voltage collector current	I_{CES}	$V_{CE}=650V, V_{GE}=0V$	-	-	20	μA
Gate-emitter leakage current	I_{GES}	$V_{GE}=\pm 20V, V_{CE}=0V$	-	-	± 100	nA
Gate-emitter threshold voltage	$V_{GE(TH)}$	$V_{CE}=V_{GE}, I_C=250\mu A$	4	5	6	V
Collector-emitter saturation voltage	$V_{CE(sat)}$	$V_{GE}=15V, I_C=30A$	-	1.65	2	V
			$T_j=175^{\circ}C$	-	2	-
Diode forward voltage	V_F	$I_F=30A$	-	1.6	1.9	V
			$T_j=175^{\circ}C$	-	1.3	-
Dynamic Characteristics						
Input Capacitance	C_{ies}	$V_{CE}=25V, V_{GE}=0V,$ $f=1.0MHz$	-	1750	-	pF
Output Capacitance	C_{oes}		-	75	-	pF
Reverse Transfer Capacitance	C_{res}		-	28	-	pF
Integrated gate resistor	R_{Gint}		-	6	-	Ω
Total Gate Charge	Q_g	$V_{CC}=400V, I_C=30A,$ $V_{GE}=15V$	-	63.5	-	nC
Gate-to-emitter charge	Q_{ge}		-	13.5	-	nC
Gate-to-collector charge	Q_{gc}		-	23	-	nC
Internal emitter inductance measured 5mm (0.197 in.) from case	L_E		-	7	-	nH



■ Switching Characteristic, Inductive Load, at $T_J=25^{\circ}\text{C}$

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
IGBT Switching Characteristics						
Turn-On Delay Time	$t_{d(on)}$	$V_{CC}=400V, I_C=30A,$ $V_{GE}=0/15V, R_g=10\Omega$ Inductive load	-	28	-	ns
Turn-On Rise Time	t_r		-	40	-	ns
Turn-Off Delay Time	$t_{d(off)}$		-	88	-	ns
Turn-Off Fall Time	t_f		-	149	-	ns
Turn-on energy	E_{on}		-	0.89	-	mJ
Turn-off energy	E_{off}		-	0.41	-	mJ
Body Diode Characteristics						
Reverse Recovery Time	t_{rr}	$V_R=400V, I_F=30A,$ $di/dt=100A/us$	-	32	-	ns
Reverse Recovery Charge	Q_{rr}		-	0.28	-	μC
Peak Reverse Recovery Current	I_{rrm}		-	18	-	A

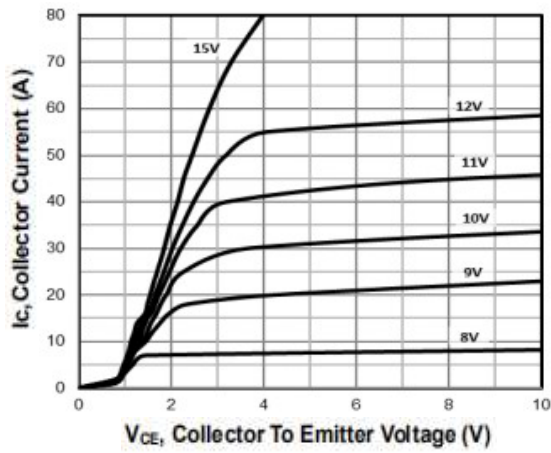
■ Switching Characteristic, Inductive Load, at $T_J=150^{\circ}\text{C}$

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
IGBT Switching Characteristics						
Turn-On Delay Time	t _{d(on)}	V _{CC} =400V,I _C =30A, V _{GE} =0/15V,R _g =10Ω Inductive load	-	32	-	ns
Turn-On Rise Time	t _r		-	40	-	ns
Turn-Off Delay Time	t _{d(off)}		-	78	-	ns
Turn-Off Fall Time	t _f		-	184	-	ns
Turn-on energy	E _{on}		-	1.18	-	mJ
Turn-off energy	E _{off}		-	0.65	-	mJ
Body Diode Characteristics						
Reverse Recovery Time	t _{rr}	V _R =400V,I _F =30A, di/dt=100A/us	-	117	-	ns
Reverse Recovery Charge	Q _{rr}		-	1.37	-	μC
Peak Reverse Recovery Current	I _{rrm}		-	19	-	A

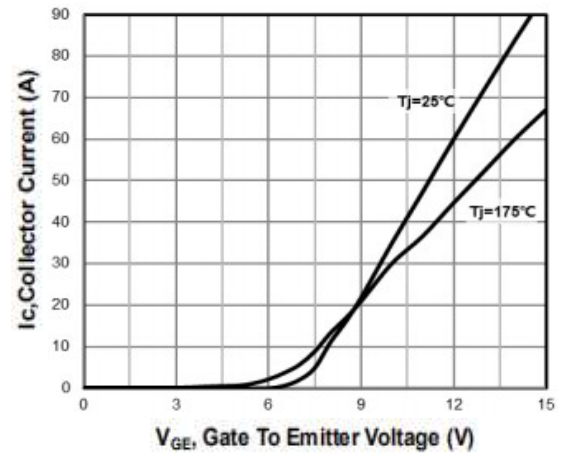




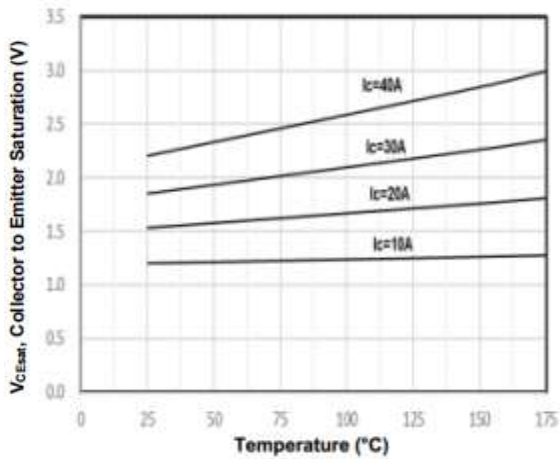
■ Characteristics Curves



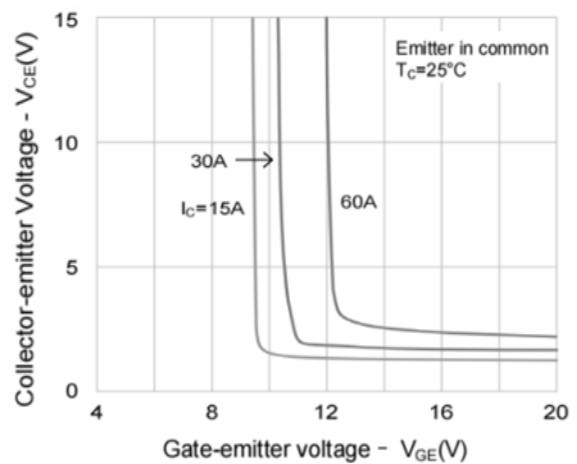
Output Characteristics



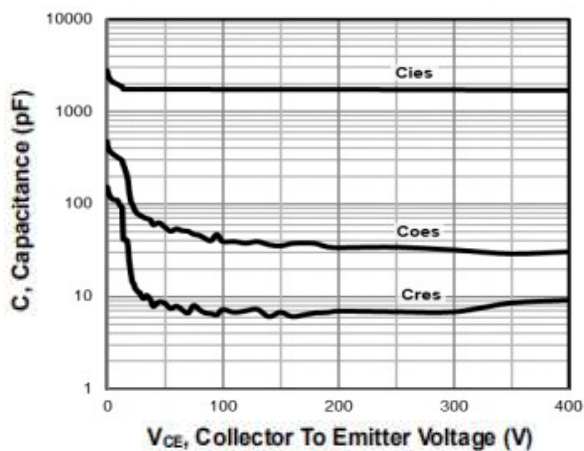
Transfer Characteristics



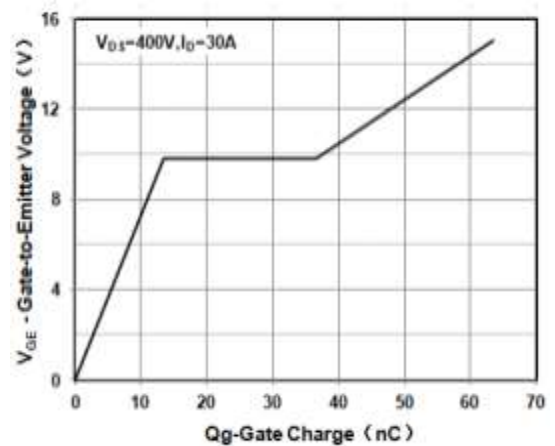
Typical collector-emitter saturation voltage as a function of junction temperature ($V_{GE} = 15V$)



Saturation voltage vs. V_{GE}

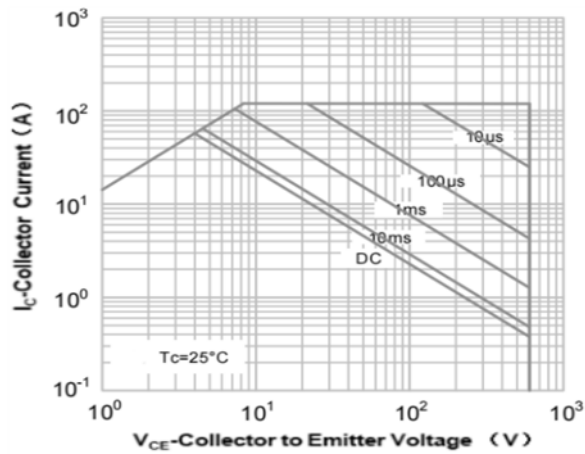


Capacitance

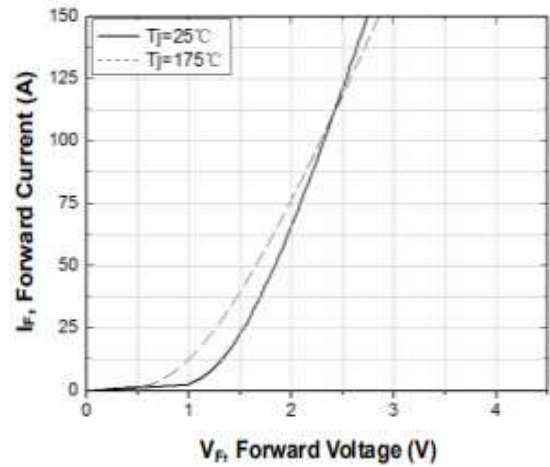


Typical gate charge





Maximum Safe Operating Area



Typ. diode forward current as a function of forward voltage

Note : The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.





■ TO-263 Package Dimensions

Unit: mm

Symbol	Min	Nom	Max	Symbol	Min	Nom	Max
A	4.42		4.72	E	8.99		9.29
B	1.22		1.4	e1	2.44	2.54	2.64
b	0.76		0.86	e2	4.98		5.18
b1	1.22		1.4	L1	14.7	15.1	15.5
b2	0.33		0.43	L2	2	2.3	2.6
C	1.22		1.35	L3	1.5		2
D	9.95		10.25	K	-0.1		0.1

